

Product Change Notification - LIAL-24BRHI755

Date: 27 Apr 2018 Product Category: Wireless Modules Affected CPNs:

Notification subject:

CCB 3338 Initial Notice: Qualification of MMT as an additional assembly site for MRF24WG0MA and MRF24WG0MB device families available in 36L module.

Notification text:

PCN Status: Initial notification.

PCN Type:

Manufacturing Change

Microchip Parts Affected:

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:

Qualification of MMT as an additional assembly site for MRF24WG0MA and MRF24WG0MB device families available in 36L module.

Pre Change:

Assembled in ABCM assembly site

Post Change:

Assembled in ABCM assembly site or assembled in MMT assembly site

Pre and Post Change Summary:

	Pre Change	Post Change				
Assembly Site	AboCom Systems, Inc. (ABCM)	AboCom Systems, Inc. (ABCM)	Microchip Technology Thailand(Branch) (MMT)			
Lead frame material	NiAu	NiAu				

Impacts to Data Sheet:

None

Change Impact:

None

Reason for Change:

To improve cycle time by qualifying MMT as an additional assembly site.

Change Implementation Status:

In Progress

Estimated Qualification Completion Date:

May 2018

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report



and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

Time Table Summary:

	April 2018				May 2018				
	14	15	16	17	18	19	20	21	22
Initial PCN Issue Date				Х					
Qual Report Availability									Х
Final PCN Issue Date									Х

Method to Identify Change:

Traceability code

Qualification Plan:

Please open the attachments included with this PCN labeled as PCN_#_Qual Plan.

Revision History:

April 27, 2018: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

PCN_LIAL-24BRHI755_QUAL_PLAN.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Affected Catalog Part Numbers (CPN)

MRF24WG0MAH-I/RM MRF24WG0MA-I/RM MRF24WG0MA-I/RM10B MRF24WG0MA-I/RMMAC MRF24WG0MAR-I/RM MRF24WG0MAR-I/RMMAC MRF24WG0MART-I/RM MRF24WG0MART-I/RMMAC MRF24WG0MAT-I/RM MRF24WG0MAT-I/RMMAC MRF24WG0MB-I/RM MRF24WG0MB-I/RMMAC MRF24WG0MBR-I/RM MRF24WG0MBR-I/RMMAC MRF24WG0MBRT-I/RM MRF24WG0MBRT-I/RMMAC MRF24WG0MBT-I/RM MRF24WG0MBT-I/RMMAC